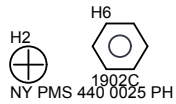
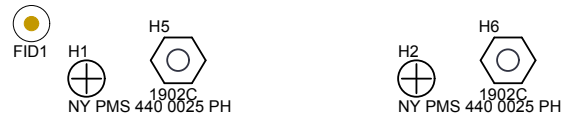


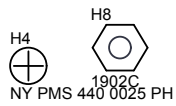
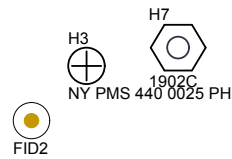
A

A



PCB Number: XX####  
PCB Rev: E1

PCB  
LOGO  
Texas Instruments



LBL1

PCB Label

Size: 0.65" x 0.20 "

ZZ1

### Label Assembly Note

This Assembly Note is for PCB labels only

ZZ2

### Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3

### Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4

### Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.

D

D

Number: <b>XX####</b>		Rev: <b>E1</b>	Designed for: <b>Public Release</b>	Mod. Date: <b>4/17/2013</b>	
SVN Rev: Not in version control		Assembly Variant: <b>001</b>	Project Title: <b>Change in menu Project Project Options Parameter</b>		
Drawn By:		Sheet Title:	Sheet: <b>1</b> of <b>1</b>		
Engineer: <b>Enter name of project lead</b>		File: <b>PMP7944_Hardware_ANSI-B_SchDoc</b>	Size: <b>B</b>		
		Contact: <b>http://www.ti.com/support</b>	<a href="http://www.ti.com">http://www.ti.com</a>		
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1	2	3	4	5	6							
A	<div>Place Block Diagram here (if appropriate) or delete this text box. If using a block diagram from another tool, save the picture as a .bmp file. Then, use menu Place Drawing Tools Graphic to insert the .bmp file on the schematic.</div>				<table><tr><th colspan="2">Revision History</th></tr><tr><th>Revision</th><th>Notes</th></tr><tr><td> </td><td> </td></tr></table>	Revision History		Revision	Notes			A
Revision History												
Revision					Notes							
B	B											
C	C											
D	D											
1	2	3	4	5	6							

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